

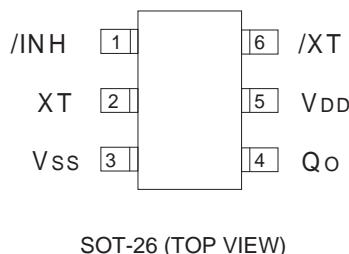
## Preliminary

- ◆ CMOS
- ◆ Oscillation Frequency 10MHz to 25MHz
- ◆ Output Frequency
  - 80MHz to 160MHz (5.0V)
  - 50MHz to 100MHz (3.3V)
- ◆ Divider Circuit & PLL Circuit Built-In
- ◆ 3 State Output
- ◆ Oscillation Capacitor & Oscillation Feedback Resistor Built-In
- ◆ Mini Mold SOT-26 Package

### General Description

The XC2173 series are high frequency, low power consumption CMOS ICs with built-in crystal oscillator, divider and clock multiplier PLL circuits. Output is selectable from any one of the following values for f<sub>0</sub> : f<sub>0</sub> x 5, f<sub>0</sub> x 6, f<sub>0</sub> x 7, f<sub>0</sub> x 8, f<sub>0</sub>/2, f<sub>0</sub>/4, f<sub>0</sub>/8. With an oscillation capacitor & oscillation feedback resistor built-in, a stable oscillator circuit can be put together using only an external crystal oscillator. By connecting an external standard clock, the above mentioned output frequencies can be achieved.

### Pin Configuration



### INH - B, Q0 Pin Function

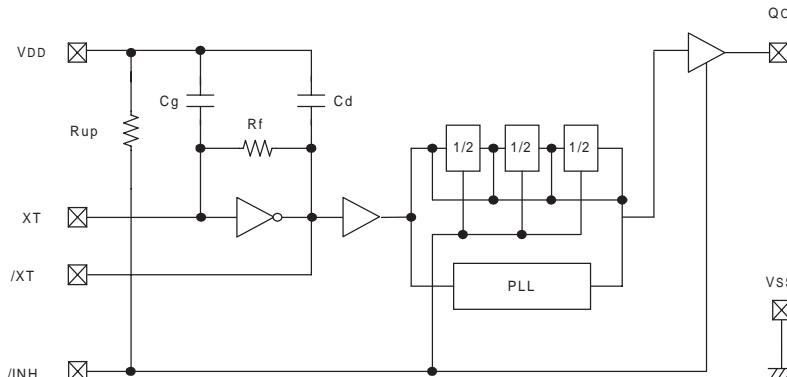
/INH	"H" or OPEN	"L" Stand-by
Q0	Divider / Multiplier Output	High Impedance

### Absolute Maximum Ratings

PARAMETER	SYMBOL	CONDITIONS	UNITS
Supply Voltage	V <sub>DD</sub>	V <sub>SS</sub> - 0.3 to V <sub>SS</sub> + 7.0	V
Input Voltage	V <sub>IN</sub>	V <sub>SS</sub> - 0.3 to V <sub>DD</sub> + 0.3	V
Power Dissipation	P <sub>d</sub>	250 *	mW
Operating Ambient Temp.	T <sub>opr</sub>	-30 to +80	°C
Storage Temp.	T <sub>stg</sub>	-55 to +125	°C

\* When measured on a glass epoxy PCB

### Block Diagram



### Applications

- Crystal Oscillation Modules
- Computer, DSP Clocks
- Communication Equipment
- Various System Clocks

### Features

- Oscillation Frequency : 10MHz to 25MHz
- Divider Ratio : f<sub>0</sub>/2, f<sub>0</sub>/4, f<sub>0</sub>/8
- Multiplier : f<sub>0</sub> x 5, f<sub>0</sub> x 6, f<sub>0</sub> x 7, f<sub>0</sub> x 8
- Output : 3 state
- Operating Voltage Range : 3.3V ± 10% and 5.0V ± 10%
- Small Consumption Current : Stand-by function included\*
  - \* oscillation intermittent in stand-by
- Ultra Small Package : SOT - 26 (150mW) mini mold

### Pin Assignment

PIN NUMBER	PIN NAME	FUNCTION
1	/INH	Stand-by control*
2	XT	Crystal Oscillator Connection (Input)
3	VSS	GND
4	Qo	Clock Output
5	VDD	Power Supply
6	/XT	Crystal Oscillator Connection (Output) / Standard Clock Input

\* Stand-by control pin has pull-up resistance built-in.

## Preliminary

## ■ Electrical Characteristics

3.3V, f0 x 8 multiplier (note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Voltage	VDD		2.97	3.3	3.63	V
'H' Level Input Voltage	VIH		2.4			V
'L' Level Input Voltage	VIL				0.4	V
'H' Level Output Voltage	VOH	CMOS : V DD = 2.97V, IOH = -8mA	2.47			V
'L' Level Output Voltage	VOL	CMOS : V DD = 2.97V, IOL = 8mA			0.4	V
Consumption Current 1	IDD1	/INH = OPEN, CL = 15pF, f = 80MHz		10		mA
Consumption Current 2	IDD2	/INH = 'L', CL = 15pF, f = 80MHz		1		mA
Input pull up resistance 1	Rup1	/INH = 'L'	2.0	4.0	6.0	MΩ
Input pull up resistance 2	Rup2	/INH = 0.7VDD	70	140	250	kΩ
Internal Oscillation Capacitance	Cg	(note 3)		13		pF
	Cd	(note 3)		13		pF
Internal Oscillation Feedback Resistance	Rf		0.3	1.0	2.0	MΩ
Output Off Leak Current	Ioz	/INH = 'L'			10	μA

5.0V, f0 x 8 multiplier (note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Voltage	VDD		4.5	5.0	5.5	V
'H' Level Input Voltage	VIH		2.4			V
'L' Level Input Voltage	VIL				0.4	V
'H' Level Output Voltage	VOH	CMOS : V DD = 4.5V, IOH = -16mA	3.9	4.2		V
'L' Level Output Voltage	VOL	CMOS : V DD = 4.5V, IOL = 16mA		0.3	0.4	V
Consumption Current 1	IDD1	/INH = OPEN, CL = 15pF, f = 160MHz		35		mA
Consumption Current 2	IDD2	/INH = 'L', CL = 15pF, f = 160MHz		5		mA
Input pull up resistance 1	Rup1	/INH = 'L'	0.5	1.0	2.0	MΩ
Input pull up resistance 2	Rup2	/INH = 0.7VDD	25	50	100	kΩ
Internal Oscillation Capacitance	Cg	(note 3)		13		pF
	Cd	(note 3)		13		pF
Internal Oscillation Feedback Resistance	Rf		100	240	400	kΩ
Output Off Leak Current	Ioz	/INH = 'L'			10	μA

note 1 : The output frequency range is 80 MHz to 100MHz with a multiplier of f0 x 8 at 3.3V

note 2 : The output frequency range is 80 MHz to 160MHz with a multiplier of f0 x 8 at 5.0V

note 3 : measured value

## Preliminary

### ■ Electrical Characteristics

**3.3V, f0 x 7 multiplier (note 1)**

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Voltage	VDD		2.97	3.3	3.63	V
'H' Level Input Voltage	VIH		2.4			V
'L' Level Input Voltage	VIL			0.4		V
'H' Level Output Voltage	VOH	CMOS : VDD = 2.97V, IOH = -8mA	2.47			V
'L' Level Output Voltage	VOL	CMOS : VDD = 2.97V, IOL = 8mA		0.4		V
Consumption Current 1	IDD1	/INH = OPEN, CL = 15pF, f = 70MHz		9		mA
Consumption Current 2	IDD2	/INH = 'L', CL = 15pF, f = 70MHz		1		mA
Input pull up resistance 1	Rup1	/INH = 'L'	2.0	4.0	6.0	MΩ
Input pull up resistance 2	Rup2	/INH = 0.7VDD	70	140	250	kΩ
Internal Oscillation Capacitance	Cg	(note 3)		13		pF
	Cd	(note 3)		13		pF
Internal Oscillation Feedback Resistance	Rf		0.3	1.0	2.0	MΩ
Output Off Leak Current	IoZ	/INH = 'L'			10	μA

**5.0V, f0 x 7 multiplier (note 2)**

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Voltage	VDD		4.5	5.0	5.5	V
'H' Level Input Voltage	VIH		2.4			V
'L' Level Input Voltage	VIL			0.4		V
'H' Level Output Voltage	VOH	CMOS : VDD = 4.5V, IOH = -16mA	3.9	4.2		V
'L' Level Output Voltage	VOL	CMOS : VDD = 4.5V, IOL = 16mA		0.3	0.4	V
Consumption Current 1	IDD1	/INH = OPEN, CL = 15pF, f = 140MHz		28		mA
Consumption Current 2	IDD2	/INH = 'L', CL = 15pF, f = 140MHz		5		mA
Input pull up resistance 1	Rup1	/INH = 'L'	0.5	1.0	2.0	MΩ
Input pull up resistance 2	Rup2	/INH = 0.7VDD	25	50	100	kΩ
Internal Oscillation Capacitance	Cg	(note 3)		13		pF
	Cd	(note 3)		13		pF
Internal Oscillation Feedback Resistance	Rf		100	240	400	kΩ
Output Off Leak Current	IoZ	/INH = 'L'			10	μA

note 1 : The output frequency range is 70 MHz to 100MHz with a multiplier of f0 x 7 at 3.3V

note 2 : The output frequency range is 80 MHz to 160MHz with a multiplier of f0 x 7 at 5.0V

note 3 : measured value

## Preliminary

## ■ Electrical Characteristics

3.3V, f0 x 6 multiplier (note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Voltage	VDD		2.97	3.3	3.63	V
'H' Level Input Voltage	VIH		2.4			V
'L' Level Input Voltage	VIL				0.4	V
'H' Level Output Voltage	VOH	CMOS : VDD = 2.97V, IOH = -8mA	2.47			V
'L' Level Output Voltage	VOL	CMOS : VDD = 2.97V, IOL = 8mA			0.4	V
Consumption Current 1	IDD1	/INH = OPEN, CL = 15pF, f = 60MHz		8		mA
Consumption Current 2	IDD2	/INH = 'L', CL = 15pF, f = 60MHz		1		mA
Input pull up resistance 1	Rup1	/INH = 'L'	2.0	4.0	6.0	MΩ
Input pull up resistance 2	Rup2	/INH = 0.7VDD	70	140	250	kΩ
Internal Oscillation Capacitance	Cg	(note 3)		13		pF
	Cd	(note 3)		13		pF
Internal Oscillation Feedback Resistance	Rf		0.3	1.0	2.0	MΩ
Output Off Leak Current	Ioz	/INH = 'L'			10	μA

5.0V, f0 x 6 multiplier (note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Voltage	VDD		4.5	5.0	5.5	V
'H' Level Input Voltage	VIH		2.4			V
'L' Level Input Voltage	VIL				0.4	V
'H' Level Output Voltage	VOH	CMOS : VDD = 4.5V, IOH = -16mA	3.9	4.2		V
'L' Level Output Voltage	VOL	CMOS : VDD = 4.5V, IOL = 16mA		0.3	0.4	V
Consumption Current 1	IDD1	/INH = OPEN, CL = 15pF, f = 120MHz		23		mA
Consumption Current 2	IDD2	/INH = 'L', CL = 15pF, f = 120MHz		5		mA
Input pull up resistance 1	Rup1	/INH = 'L'	0.5	1.0	2.0	MΩ
Input pull up resistance 2	Rup2	/INH = 0.7VDD	25	50	100	kΩ
Internal Oscillation Capacitance	Cg	(note 3)		13		pF
	Cd	(note 3)		13		pF
Internal Oscillation Feedback Resistance	Rf		100	240	400	kΩ
Output Off Leak Current	Ioz	/INH = 'L'			10	μA

note 1 : The output frequency range is 60 MHz to 100MHz with a multiplier of f0 x 6 at 3.3V

note 2 : The output frequency range is 80 MHz to 150MHz with a multiplier of f0 x 6 at 5.0V

note 3 : measured value

## Preliminary

### ■ Electrical Characteristics

**3.3V, f0 x 5 multiplier (note 1)**

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Voltage	VDD		2.97	3.3	3.63	V
'H' Level Input Voltage	VIH		2.4			V
'L' Level Input Voltage	VIL			0.4		V
'H' Level Output Voltage	VOH	CMOS : VDD = 2.97V, IOH = -8mA	2.47			V
'L' Level Output Voltage	VOL	CMOS : VDD = 2.97V, IOL = 8mA		0.4		V
Consumption Current 1	IDD1	/INH = OPEN, CL = 15pF, f = 50MHz		7		mA
Consumption Current 2	IDD2	/INH = 'L', CL = 15pF, f = 50MHz		1		mA
Input pull up resistance 1	Rup1	/INH = 'L'	2.0	4.0	6.0	MΩ
Input pull up resistance 2	Rup2	/INH = 0.7VDD	70	140	250	kΩ
Internal Oscillation Capacitance	Cg	(note 3)		13		pF
	Cd	(note 3)		13		pF
Internal Oscillation Feedback Resistance	Rf		0.3	1.0	2.0	MΩ
Output Off Leak Current	IoZ	/INH = 'L'			10	μA

**5.0V, f0 x 5 multiplier (note 2)**

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Voltage	VDD		4.5	5.0	5.5	V
'H' Level Input Voltage	VIH		2.4			V
'L' Level Input Voltage	VIL			0.4		V
'H' Level Output Voltage	VOH	CMOS : VDD = 4.5V, IOH = -16mA	3.9	4.2		V
'L' Level Output Voltage	VOL	CMOS : VDD = 4.5V, IOL = 16mA		0.3	0.4	V
Consumption Current 1	IDD1	/INH = OPEN, CL = 15pF, f = 100MHz		23		mA
Consumption Current 2	IDD2	/INH = 'L', CL = 15pF, f = 100MHz		5		mA
Input pull up resistance 1	Rup1	/INH = 'L'	0.5	1.0	2.0	MΩ
Input pull up resistance 2	Rup2	/INH = 0.7VDD	25	50	100	kΩ
Internal Oscillation Capacitance	Cg	(note 3)		13		pF
	Cd	(note 3)		13		pF
Internal Oscillation Feedback Resistance	Rf		100	240	400	kΩ
Output Off Leak Current	IoZ	/INH = 'L'			10	μA

note 1 : The output frequency range is 50 MHz to 100MHz with a multiplier of f0 x 5 at 3.3V

note 2 : The output frequency range is 80 MHz to 125MHz with a multiplier of f0 x 5 at 5.0V

note 3 : measured value

## Preliminary

## ■ Switching Characteristics

3.3V

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Rise Time	tr	CL = 15pF, 0.1VDD to 0.9VDD (note 1)		2.0		ns
Output Fall Time	tf	CL = 15pF, 0.9VDD to 0.1VDD (note 1)		2.0		ns
Output DUTY Cycle	DUTY	CMOS : 0.5VDD, CL = 15pF	45		55	%
Output Disenable (Delay Time)	tplz	CL = 15pF (note 1)			100	ns
Output Enable (Delay Time)	tpzl	CL = 15pF (note 1)			100	ns
Jitter	tj	1 $\sigma$ (note 1)		50		ps

5.0V

Ta = 25°C

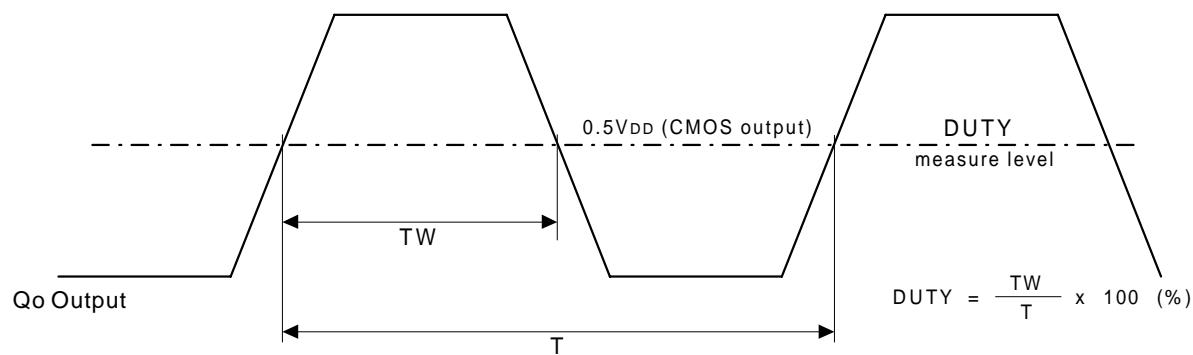
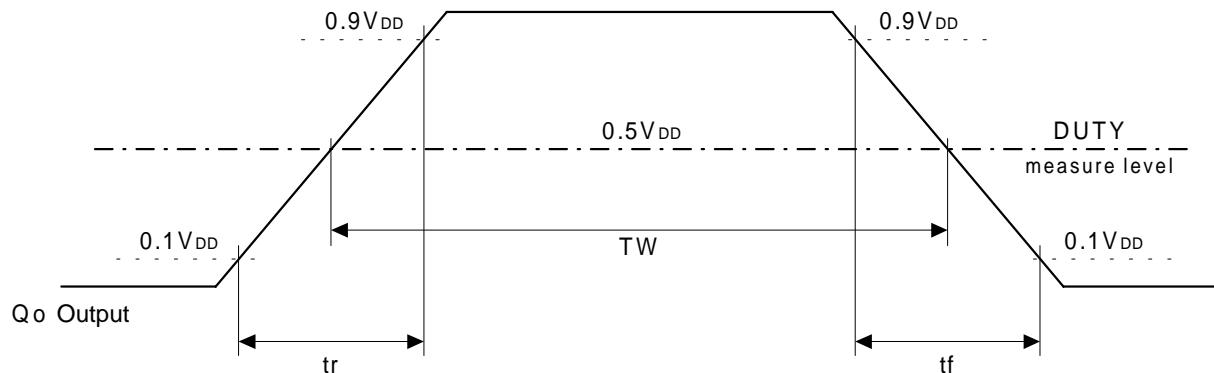
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Rise Time	tr	CL = 15pF, 0.1VDD to 0.9VDD (note 1)		1.5		ns
Output Fall Time	tf	CL = 15pF, 0.9VDD to 0.1VDD (note 1)		1.5		ns
Output DUTY Cycle	DUTY	CMOS : 0.5VDD, CL = 15pF	45		55	%
Output Disenable (Delay Time)	tplz	CL = 15pF (note 1)			100	ns
Output Enable (Delay Time)	tpzl	CL = 15pF (note 1)			100	ns
Jitter	tj	1 $\sigma$ (note 1)		50		ps

note 1 : measured value

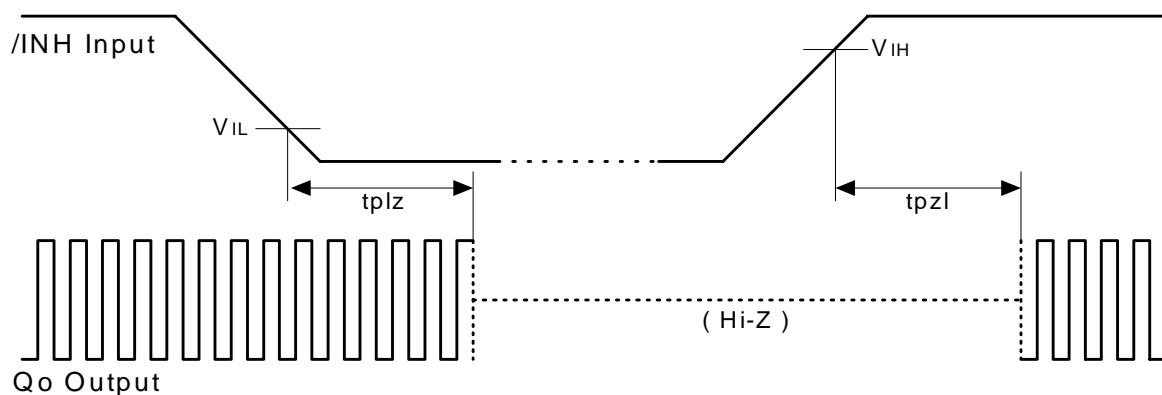
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### ■ Switching Characteristics

1) CMOS Level : tr, tf, Duty



2) Output Disable/Enable Delay Time



\*) /INH pin input waveform :  $tr = tf = \text{less than } 10 \text{ ns}$

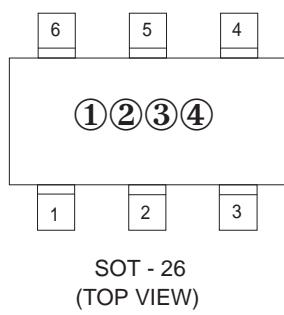
## Preliminary

### ■ Ordering Information

XC2173 ① ② ③ ④ ⑤ ⑥

DESIGNATOR	SYMBOL	DESCRIPTION
①	C	CMOS (VDD/2)
②	M	Multiplier Output
	D	Divider Output
③		Multiplier Ratio or Divider Ratio
	2	$f_0 / 2$
	4	$f_0 / 4$
	5	$f_0 \times 5$
	6	$f_0 \times 6$
	7	$f_0 \times 7$
	8	$f_0 / 8 \text{ & } f_0 \times 8$
		Input Oscillation Frequency Range
④	1	10MHz to 25MHz
⑤	M	SOT-26 Package
⑥	R	Embossed Tape (orientation of device : right)
	L	Embossed Tape (orientation of device : left)

### ■ Marking



① Represents Product Type  
\* To Be Determined

② Represents the Output

SYMBOL	OUTPUT
M	Multiplier
D	Divider

③ Represents the Multiplier and/or Divider Ratio

SYMBOL	M/D
2	$f_0/2$
4	$f_0/4$
5	$f_0/5$
6	$f_0 \times 6$
7	$f_0 \times 7$
8	$f_0/8 \text{ & } f_0 \times 8$

④ Represents the Assembly Lot No.  
(based on internal standards)